

Glass Passivated Bridge Rectifiers

FEATURES

- Glass passivated junction
- Ideal for printed circuit board
- Reliable low cost construction
- UL Recognized File # E-326243
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

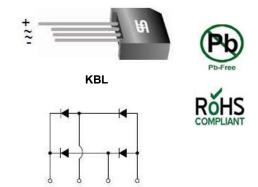


Case: KBL

Molding compound, UL flammability classification rating 94V-0 Base P/N with suffix "G" on packing code - halogen-free **Terminal:** Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 1A whisker test **Polarity:** Polarity as marked on the body

Weight: 5.6 g (approximately)



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T _A =25℃ unless otherwise noted)									
DADAMETED	SYMPOL	KBL KBL		KBL	KBL	KBL KBL	KBL	KBL	1114
PARAMETER	SYMBOL	401G	402G	403G	404G	405G	406G	407G	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current	I _{F(AV)}		-		4				Α
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	150				А			
Rating for fusing (t<8.3mS)	l ² t				93				A ² s
Maximum instantaneous forward voltage (Note 1) I_F = 2A I_F = 4A	V _F	1.0 1.1				V			
$\label{eq:maximum} \begin{array}{ll} \mbox{Maximum DC reverse current} & \mbox{T_J=25 $^{\circ}$C} \\ \mbox{at rated DC blocking voltage} & \mbox{T_J=125 $^{\circ}$C} \end{array}$	I _R	10 500				μA			
Typical thermal resistance	$R_{ heta JA}$	2.4 19			°C/W				
Operating junction temperature range	T _J	- 55 to +150			οС				
Storage temperature range	T _{STG}	- 55 to +150		οС					

Note 1: Pulse Test with PW=300µs,1% Duty Cycle



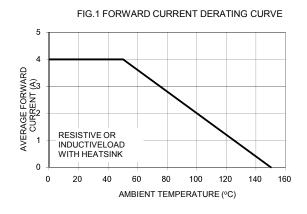
ORDERING INFORMATION						
PART NO.	PACKING CODE	GREEN COMPOUND	PACKAGE	PACKING		
		CODE				
KBL40xG (Note 1)	ТО	Suffix "G"	KBL	500 / Tray		

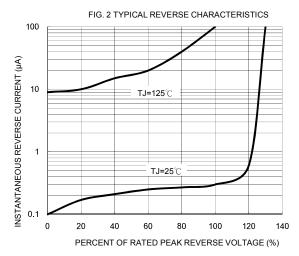
Note 1: "x" defines voltage from 50V (KBL401G) to 1000V (KBL407G)

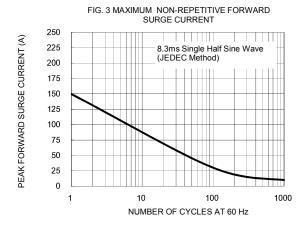
EXAMPLE						
PREFERRED P/N	PART NO.	PACKING CODE	GREEN COMPOUND CODE	DESCRIPTION		
KBL407G T0	KBL407G	T0				
KBL407G T0G	KBL407G	T0	G	Green compound		

RATINGS AND CHARACTERISTICS CURVES

(TA=25°C unless otherwise noted)







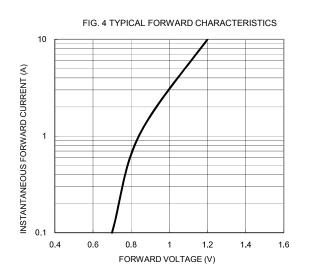
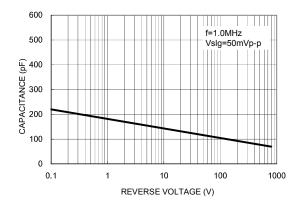
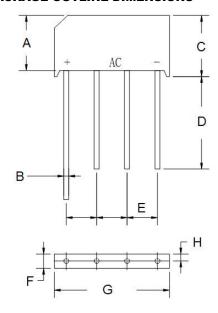




FIG. 5 TYPICAL JUNCTION CAPACITANCE



PACKAGE OUTLINE DIMENSIONS



DIM.	Unit	(mm)	Unit (inch)			
DIIVI.	Min	Max	Min	Max		
Α	13.70	14.70	0.539	0.579		
В	1.20	1.30	0.047	0.051		
С	15.20	16.30	0.598	0.642		
D	19.00	1	0.748	-		
Е	4.60	5.60	0.181	0.220		
F	5.50	6.50	0.217	0.256		
G	18.50	19.50	0.728	0.768		
Н	2.1 (TYP)		0.083 (TYP)			

MARKING DIAGRAM



P/N = Specific Device Code
G = Green Compound
YWW = Date Code
F = Factory Code



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